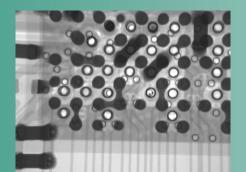
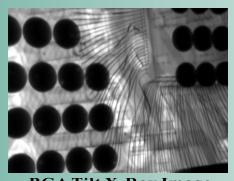


QFN X-Ray Image



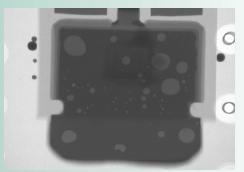
BGA Bridging and Voids

FBGA X-Ray Image



BGA Tilt X-Ray Image

IC Bond Wire Image



Transistor Void/Solder Balls

Product Description

AX-7100L



Specifications

X-ray Tube Type	Sealed Tube
X-ray Tube Voltage	0-80kV
X-ray Tube Current	0.20mA
X-ray Tube Focal Spot	15 micron
Image Detector	4/2" Image Intensifier
Imaging Camera	2MP Digital
Magnification	Up to 200X
Maximum PCB Size	400 x 450mm
Maximum Inspection Area	400 x 400mm
Tilt Range	+/- 70 degrees
Step and Repeat Programming	N/A
Image Processing Software	AX-DXI
X-ray Machine Safety	<1 micro Sv/hr
Machine Dimensions (WxDxH)	1000 x 850 x 1590mm
Machine Weight	600Kg
Machine Operating Temp	0-40°C (Humidity 30-70RH)
Machine Line Voltage	100VAC-230VAC, 50/60Hz
Machine Power Consumption	0.5kW (max)

Applications

- BGA bridging: Excellent
- BGA voids: Excellent (measure using BGA void/area software)
- BGA opens: Good (requires PCB tilt ~ 65-70°)
- BGA excessive/insufficient: Excellent (measure using BGA void/area software)
- CSP bridging: Excellent (requires ~ 100X magnification)
- CSP voids: Good (requires ~ 100X magnification)
- CSP opens: Marginal
- CSP excessive/insufficient: Excellent (requires ~ 100X magnification)
- Flip Chip bridging: Good (requires ~200X magnification)
- Flip Chip voids: Marginal
- Flip Chip opens: Marginal
- Flip Chip excessive/insufficient: Good (requires ~ 200X magnification)
- QFN bridging & voids: Excellent (measure using QFN void/area software)
- QFP opens: Good (requires ~150X magnification/PCB tilt ~ 45-50°)
- SMT chip component attach: Excellent
- I/C internal structure: Good for bond wire and die attachment
- MLB inner layer analysis: Excellent for pad stack alignment and drill offset

X-ray Safety Commitment: All x-ray machines manufactured by Unicomp Technology meet the FDA-CDRH Regulation CFR 21 1020.40 Subchapter J for cabinet x-ray systems. The FDA-CDRH standard for cabinet x-ray systems states that radiation emissions will not exceed .5 millirem/hr. 2" from any external surface. Our machines are typically 15 times less emission.

Certificates of Compliance: FDA Accession Number: 1231200-000 CE Reference Number: CE 11710



USA Phone: +1 262-548-9114 China Phone +86 1886-150-9350 Email: <u>ken@cd-support.com</u> Support Offices: Arizona, Wisconsin, Texas, Brazil, China, Europe Website: <u>www.unicomp.cn</u>